



N-Channel Enhancement Mode MOSFET

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Features

- $V_{DS} = 20V, I_D = 0.8A$ $R_{DS(ON)} < 250m \Omega @ V_{GS} = 4.5V$ $R_{DS(ON)} < 300m \Omega @ V_{GS} = 2.5V$
- ESD Protection

Package and Pin Configuration

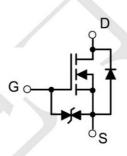


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Application

- Load/Power Switching
- · Interfacing Switching
- Battery Management for Ultra Small Portable Electronics
- Logic Level Shift

Circuit diagram



Absolute Maximum Ratings (T_A=25°C unless otherwise noted)

Parameter	Symbol	Value	Unit
Drain-Source Voltage	V _{DS}	20	V
Gate-Source Voltage	V _{GS}	±8	V
Continuous Drain Current	I _D	0.8	Α
Pulsed Drain Current (t=300µs) (1)	I _{DM}	1.8	Α
Power Dissipation (2)	P _D	280	mW
Thermal Resistance from Junction to Ambient	R _{θJA}	452	°C/W
Junction Temperature	TJ	150	°C
Storage Temperature	T _{STG}	-55~ +150	$^{\circ}$



TPNTA4153NT1G

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Electrical Characteristics (T_A = 25°C unless otherwise noted)

Parameter	Symbol	Test Condition	Min	Type	Max	Unit	
Static Characteristics					N 16		
Drain-source breakdown voltage	V _{(BR)DSS}	V _{GS} = 0V, I _D =250μA	20			V	
Zero gate voltage drain current	I _{DSS}	V _{DS} =20V,V _{GS} = 0V			1	μA	
Gate-body leakage current	I _{GSS}	V _{GS} =±8 V, V _{DS} = 0V			±10	μΑ	
Gate threshold voltage ⁽³⁾	V _{GS(th)}	V _{DS} =V _{GS} , I _D =250μA	0.5	0.75	1.1	V	
Drain-source on-resistance ⁽³⁾	R _{DS(on)}	V _{GS} =4.5V, I _D =550mA		180	250	mΩ	
Stain Source on Todistance	1 100(011)	V _{GS} =2.5V I _D =450mA		230	300	11142	
Forward tranconductance	g FS	V _{DS} =5 V, I _D =500mA		1.7		S	
Dynamic characteristics ⁽⁴⁾							
Input Capacitance	C _{iss}				120		
Output Capacitance	Coss	V_{DS} =16V, V_{GS} =0V, f =1MHz			20	pF	
Reverse Transfer Capacitance	C _{rss}				15		
Switching Characteristics ⁽⁴⁾							
Turn-on delay time	t _{d(on)}			6.7			
Turn-on rise time	t _r	V_{DD} =10V, I_{D} =500mA,		4.8			
Turn-off delay time	t _{d(off)}	V_{GS} =4.5V, R_{G} =10 Ω		17.3		ns	
Turn-off fall time	t _f	1					
Source-Drain Diode characteristics				-0.00			
Diode Forward voltage ⁽³⁾	V _{DS}	I _S =0.15A, V _{GS} = 0V			1.2	V	

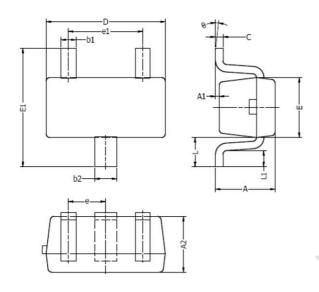


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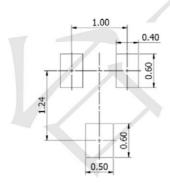
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SOT523 Package Outline Drawing



Suggested	Land	Pattern
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DIM	MILLIM	ETERS	INCI	HES
DIM		MAX	MIN	MAX
Α	0.70	0.90	0.028	0.035
A1	0.00	0.10	0.000	0.004
A2	0.70	0.80	0.028	0.031
b1	0.15	0.25	0.006	0.010
b2	0.25	0.35	0.010	0.014
С	0.10	0.20	0.004	0.008
D	1.50	1.70	0.059	0.067
E	0.70	0.90	0.028	0.035
E1	1.45	1.75	0.057	0.069
е	0.50 TYP.		0.020	TYP.
e1	0.90	1.10	0.035	0.043
L	0.40 REF.		0.016 REF.	
L1	0.10	0.30	0.004	0.012
θ	O °	8°	O°	8°

- Above package outline conforms to JEITA EAIJ ED-7500A SC-75A.
 Dimensions are exclusive of Burrs, Mold Flash & Tie Bar extrusions.

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